

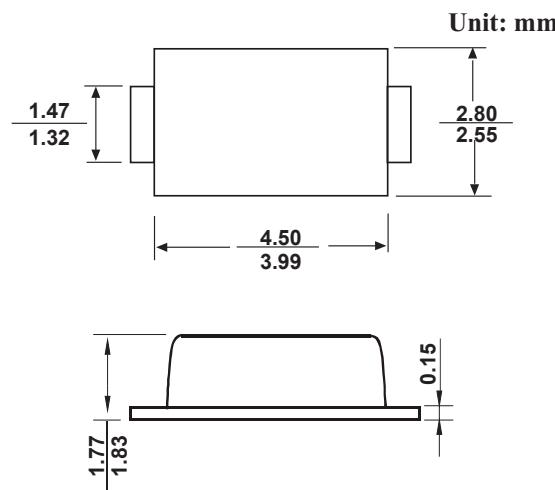
SMAF PLASTIC SILICON RECTIFIERS

Features

- Metal silicon junction, majority carrier conduction
- High surge capability
- High temperature soldering guaranteed: 260° C/10 seconds
- High current capability, low forward voltage drop
- RoHS Compliant

Mechanical Data

- Case: SMAF molded plastic
- Molding compound, UL flammability classification rating 94V-0
- Terminals: Solder plated, solderable per MIL- STD-202, Method 208
- Polarity: Color band denotes cathode end



MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Characteristic	Symbol	SS22F	SS23F	SS24F	SS245F	Units
Peak repetitive reverse voltage	V _{RRM}	20	30	40	45	V
RMS reverse voltage	V _{RMS}	14	21	28	31.5	V
DC blocking voltage	V _{DC}	20	30	40	45	V
Maximum average forward output current	I _{F(AV)}		2.0			A
Peak forward surge current, 8.3ms single half-sine-wave	I _{FSM}		50			A
Typical thermal resistance (Note 1)	R _{θJA}		78			
	R _{θJC}		18			°C /W
	R _{θJL}		20			
Operating junction temperature range	T _J		- 55 ---- + 125			°C
Storage temperature range	T _{STG}		- 55 ---- + 150			°C

Note:

1. Device mounted on PCB with 10 mm x 20 mm x 0.1mm copper pad areas

Parameter	Symbol	Test conditions	Typ.	Max.	Units
Maximum instantaneous forward voltage (Note 1)	V _F	F _I = 2.0A	@ T _A =25°C	--	0.5 V
Maximum Reverse current (Note 2)	I _R	Rated V _R ,	@ T _J =25°C @ T _J =100°C	--	500 μ A 20 m A

Note:

1. Pulse test: 300us pulse width, 1 % duty cycle

2. Pulse test: Pulse width 40ms

RATINGS AND CHARACTERISTIC CURVES

Fig.1-Forward Current Derating Curve

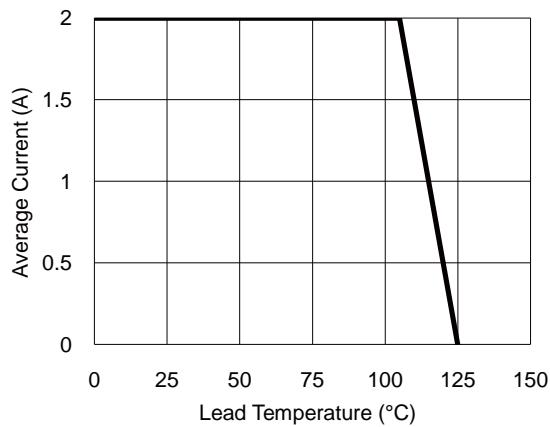


Fig.2- Surge Current Derating Curve

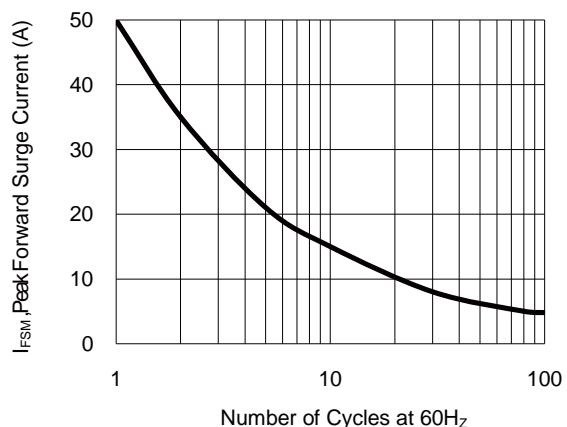


Fig.3- Typical Forward Voltage Characteristic

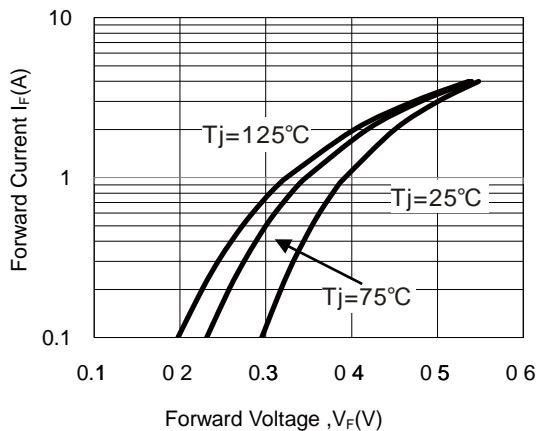


Fig.4- Typical Reverse Characteristic

